

P3A9606, LOW VOLTAGE TRANSLATOR FOR I3C BUS APPLICATIONS



Dual supply, 0.72 V to 1.98 V translator with auto direction sensing, enables bidirectional voltage level translation without the need for direction control in I3C, I²C-bus and SPI applications.

The P3A9606 is a 2-bit, dual supply translating transceiver with auto direction sensing, that enables bidirectional voltage level translation for both open-drain as well as push-pull application which allows for I3C, I²C and SPI protocols level translation. The device was specifically designed to support I3C which initiates the communication sequence using an open-drain I²C-bus, then switches to the 12.5 MHz push-pull I3C bus. The device is useful in any low voltage open-drain or push-pull bidirectional signal translation application.

EASY TO USE

The P3A9606, a dual supply translating transceiver with auto direction sensing, enables bidirectional voltage level translation without the need for direction control up to 26 MHz.

WIDE VOLTAGE LEVEL TRANSLATION

- $V_{cc}(A)$: 0.72 V to 1.98 V and $V_{cc}(B)$: 0.72 V to 1.98 V with $V_{cc}(A) \le V_{cc}(B)$
- Voltage nodes 0.8 V, 1.0 V, 1.2 V, 1.5 V and 1.8 V

SMALLER AND THINNER PACKAGE

X2SON8, super-thin package, with 0.35 mm pitch, and 1.35 mm x 1.0 mm x 0.32 mm body

PROTECTIVE CIRCUITRY

- I_{OFF} circuitry provides partial power-down mode operation
- Accepts voltage inputs up to 1.98 V with overvoltage tolerance to 1.98 V

KEY FEATURES AND ADVANTAGES

Applications

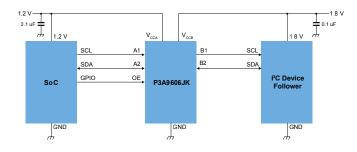
- I3C Bus, I²C-bus and SPI level translation
- Servers
- Notebooks/Tablets
- Smartphones



Application diagrams

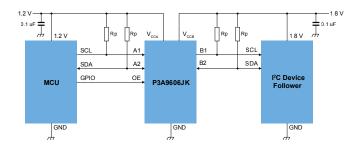
13C BUS LEVEL TRANSLATION

SPI LEVEL TRANSLATION



1.2 V 1.8 V /CS A1. B1 /CS SCLK A2 P3A9606JK.1 B2 SCLK OE GND A1_ SPI Device Follower MOSI A2 MCU MISO OE Rd GND V_{CCA} /INT Α1 B1 /INT A2 P3A9606JK.3 B2 GPIO OE GND GND GND

I²C-BUS LEVEL TRANSLATION



ORDERING INFORMATION

Type number	Top-side marking	Package				
		Name	Description	Version		
P3A9606JK	Tx ^[1]	X2SON8	super thin small outline package, no leads; 8 terminals; 0.35 mm pitch; 1.35 mm x 1.0 mm x 0.32 mm body	SOT2015-1		

 $^{^{\}left[1\right]}$ "x" changes based on date code.

ORDERING OPTIONS

Type number	Orderable part number	Package	Packing method	Minimum order quantity	Temperature
P3A9606JK	P3A9606JKZ	X2SON8	Reel 13" Q1/T1 *standard mark SMD with SSB ^[1]	20000	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$

^[1] This packing method uses a Static Shielding Bag (SSB) solution. Material should be kept in the sealed bag between uses.

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